

RS940-MI600

Data Sheet

NB개발담당

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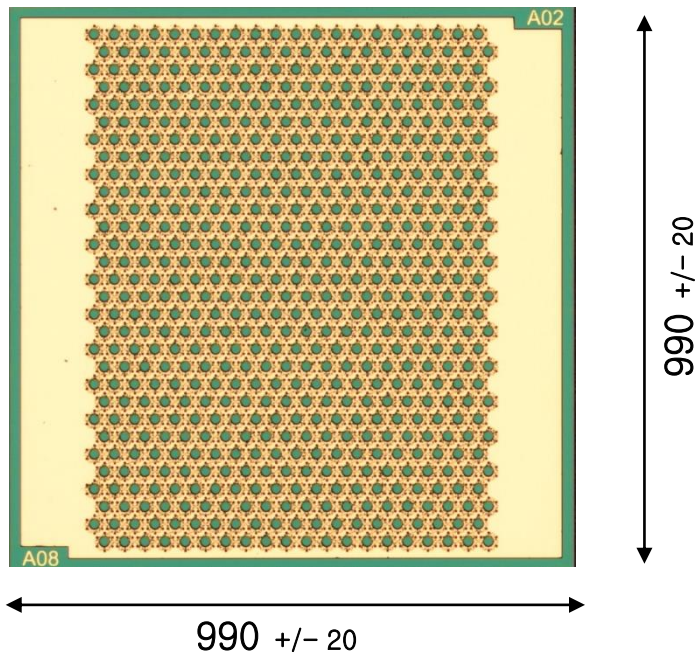
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1. Chip dimensions

Unit : μm

Size : 990 x 990

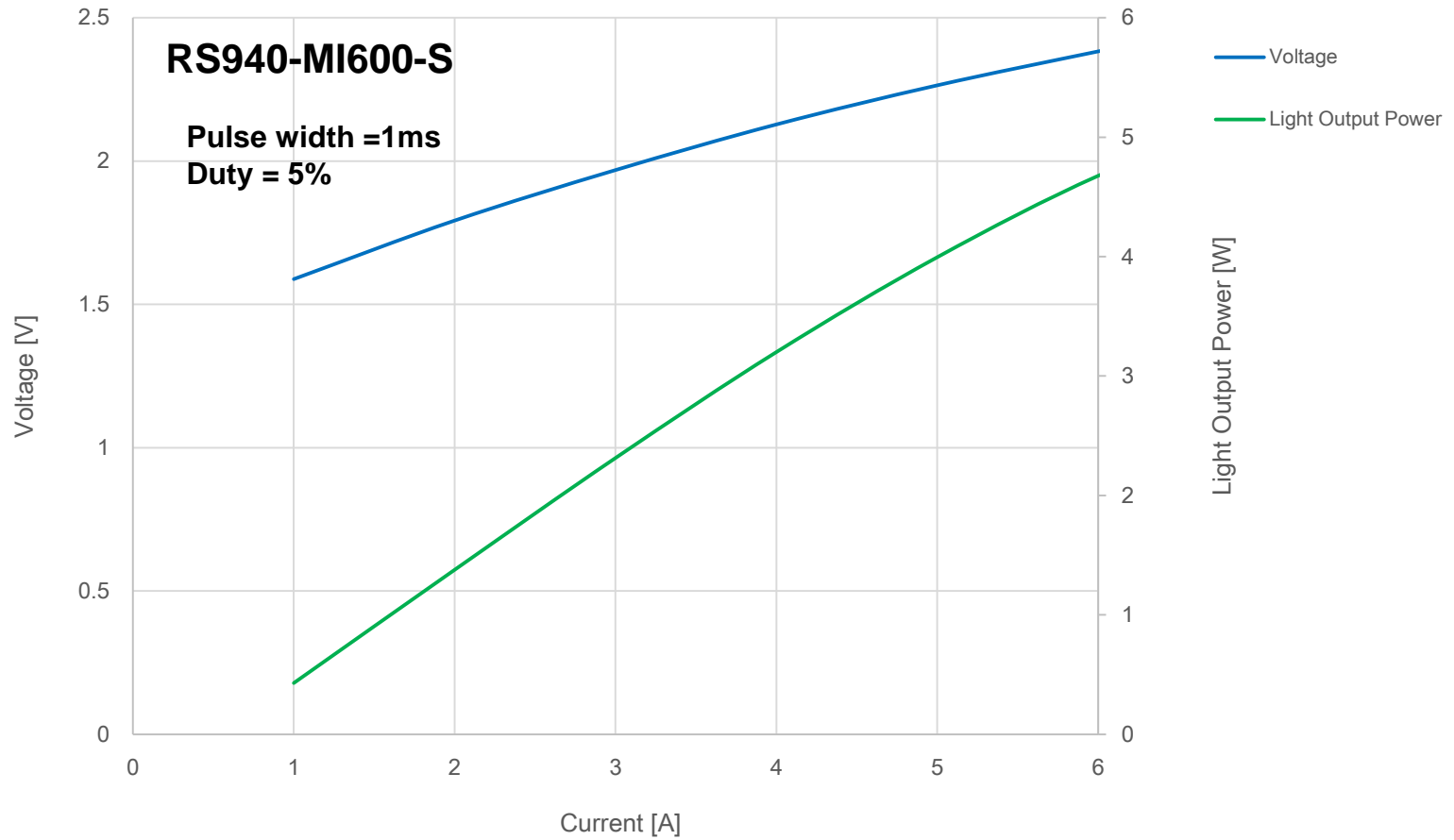
Chip : top side view



Cathode : backside

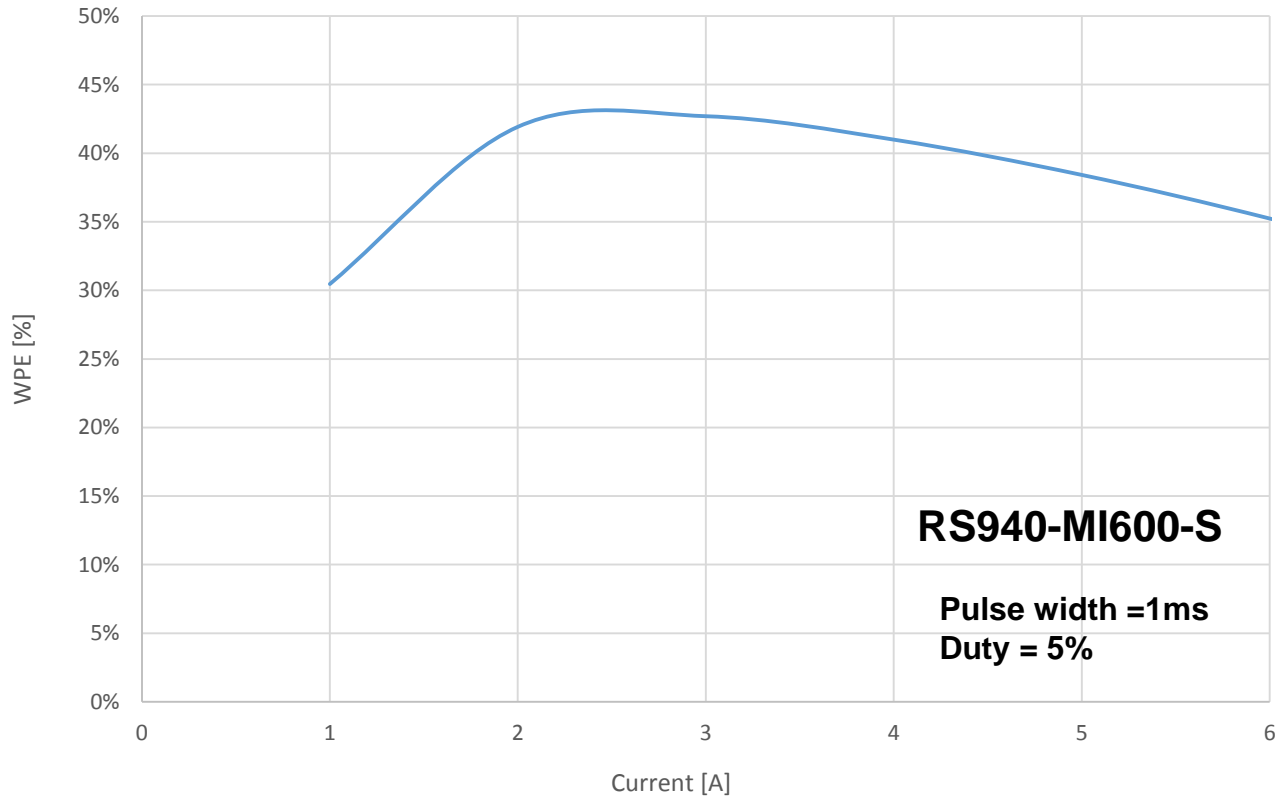
Thickness : 150 \pm 20

2. L-I-V (25°C)



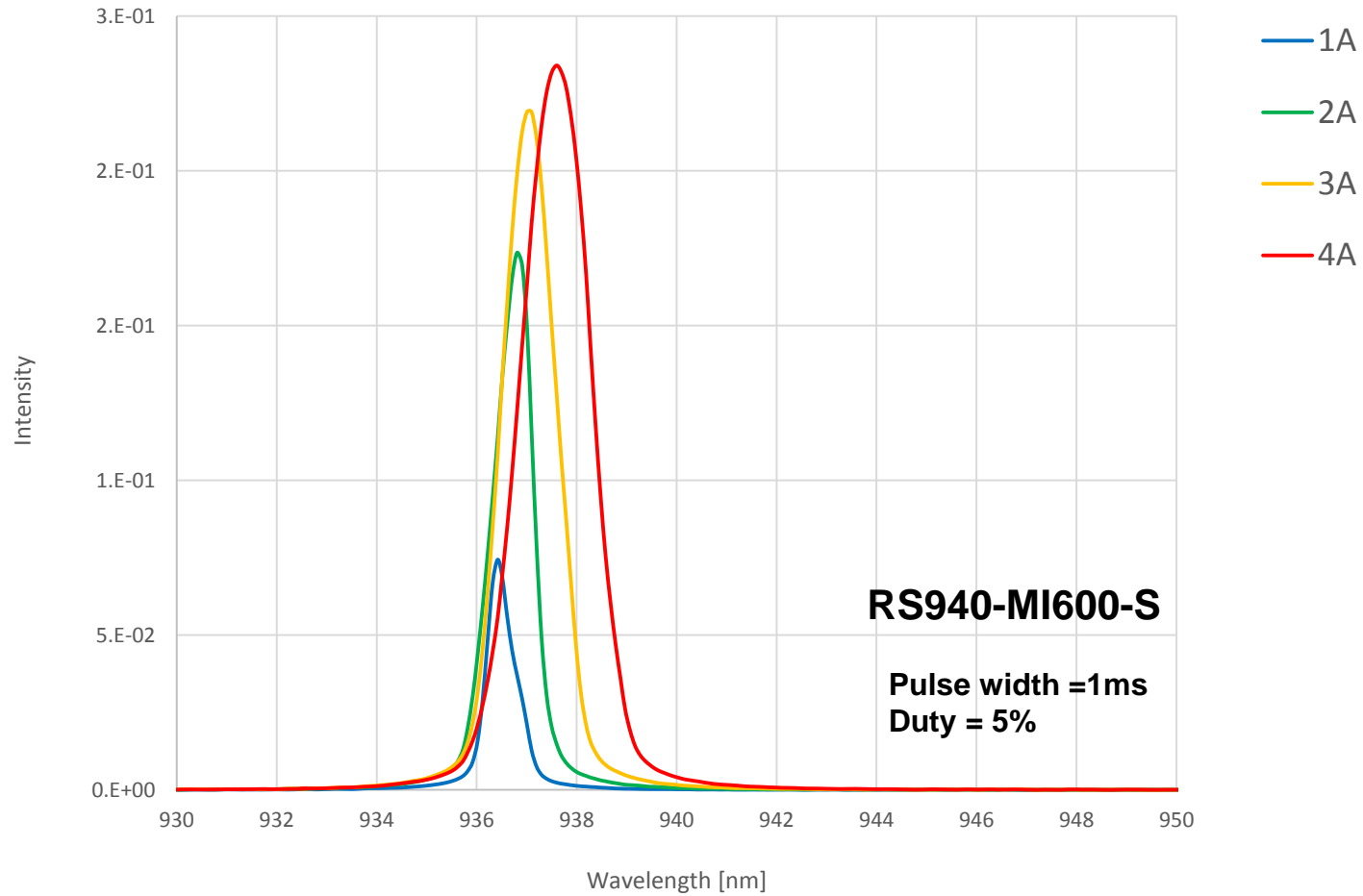
($T = 25^{\circ}\text{C}$ unless otherwise stated)

3. WPE vs Current (25°C)



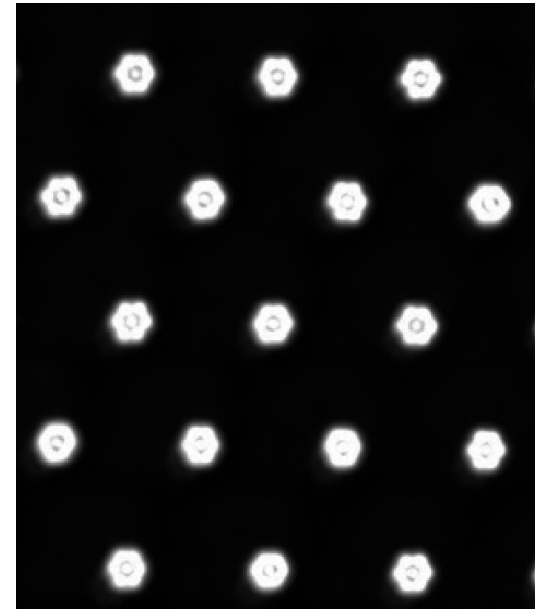
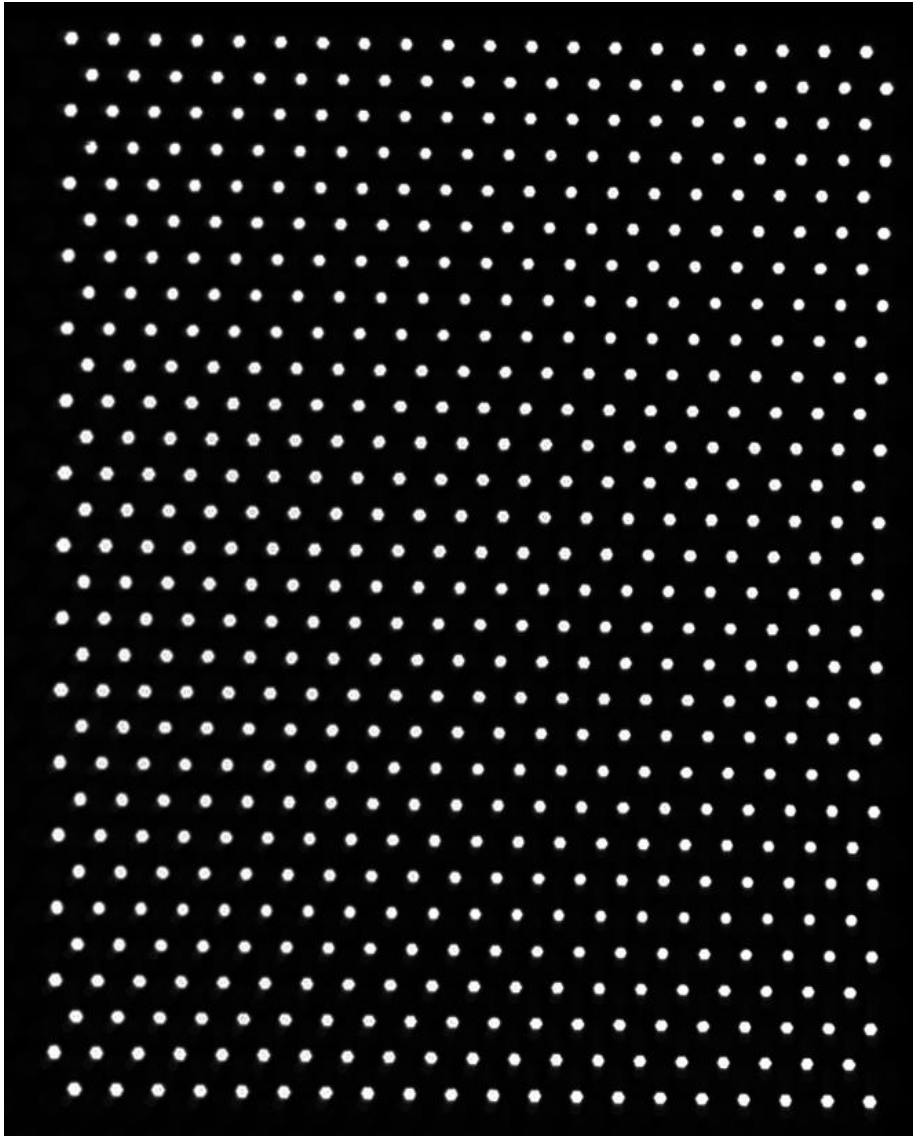
(T = 25°C unless otherwise stated)

4. Spectrum vs Current (25°C)



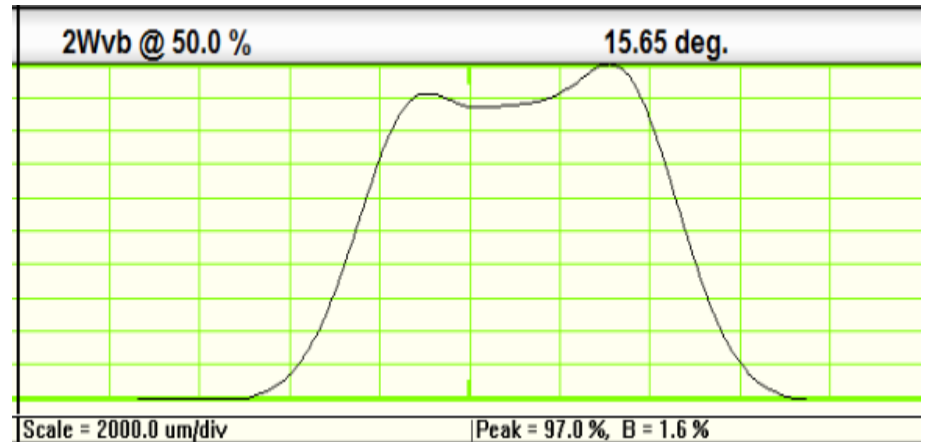
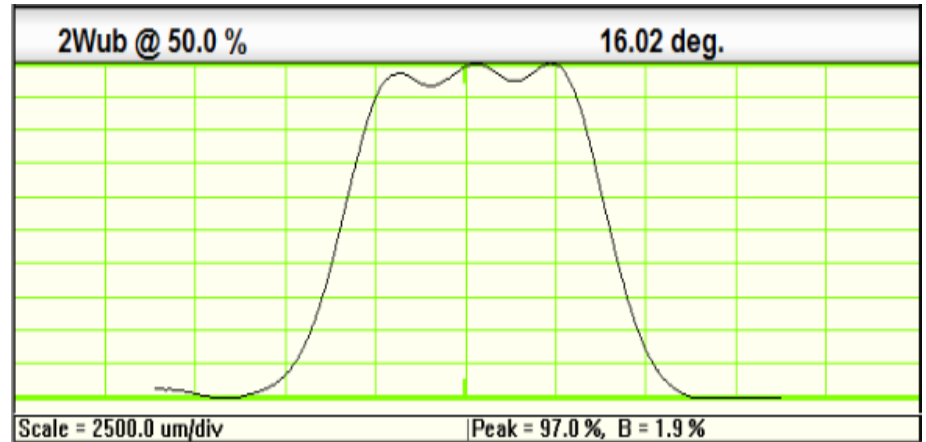
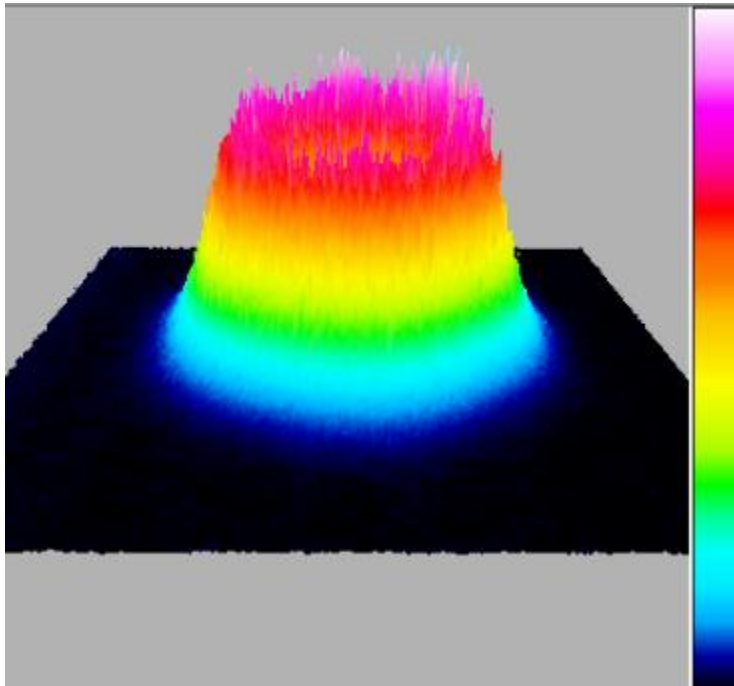
(T = 25°C unless otherwise stated)

5. Near-field (25°C)



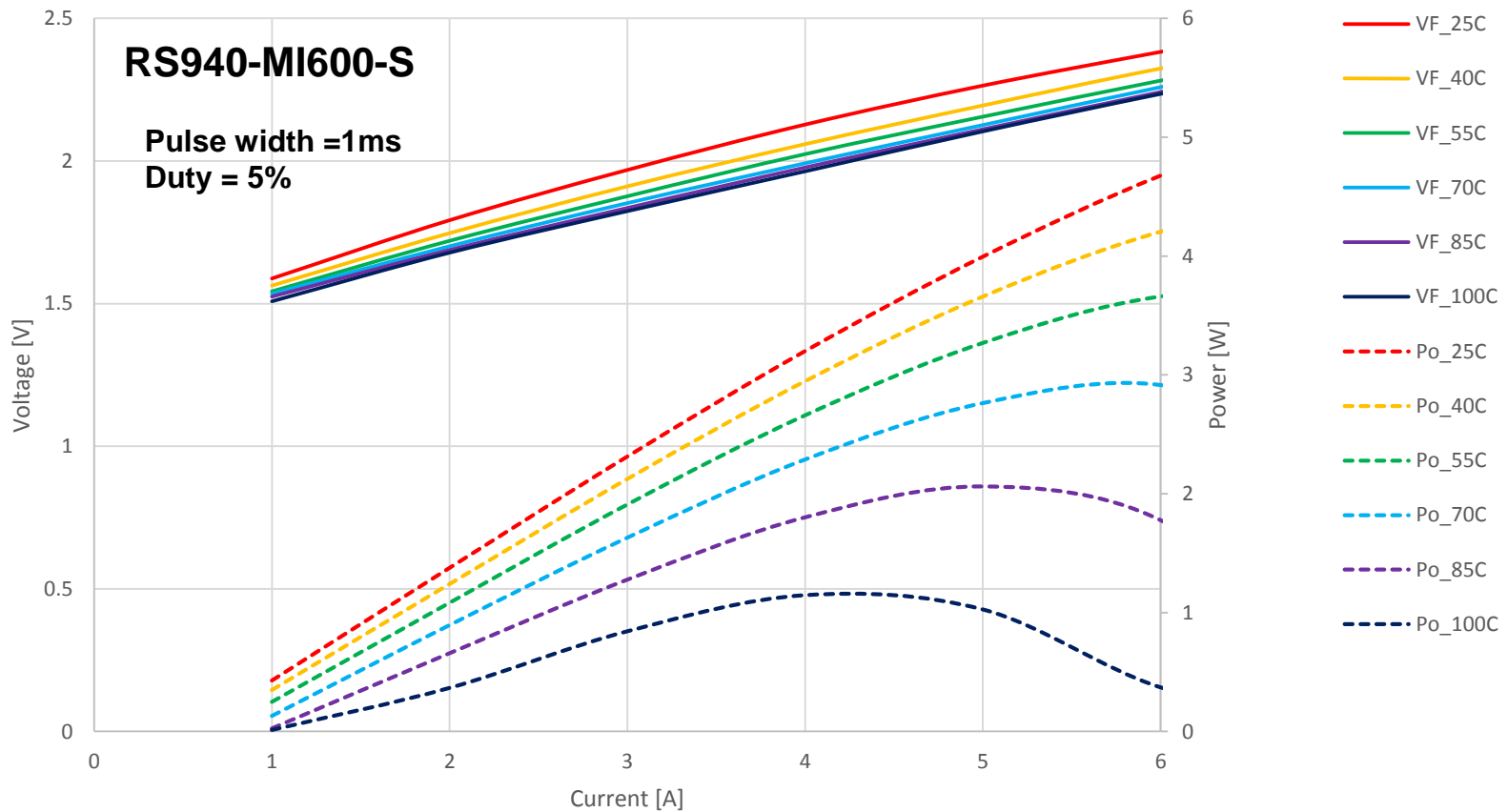
($T = 25^{\circ}\text{C}$ unless otherwise stated)

6. Far-field (25°C)

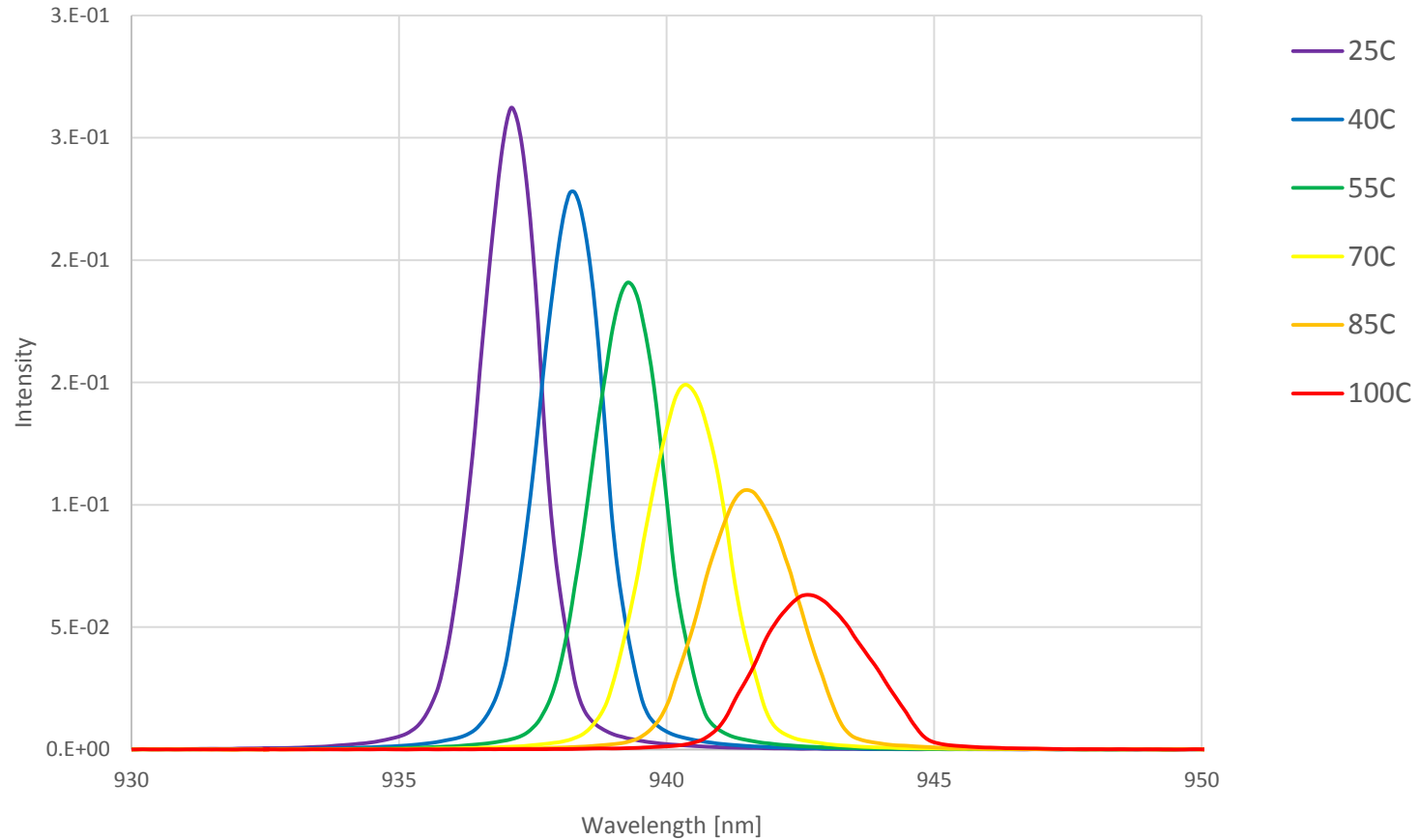


(T = 25°C unless otherwise stated)

7. L-I-V vs Temperature



8. Spectrum vs Temperature





THANK YOU!

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